



Product Change Notification

Change Notification #: 117785 - 00
Change Title: Intel® Server System R2208WF0ZSR,
 Intel® Server System R2312WFTZSR,
 PCN 117785-00, Label,
 Update Packaging Regulatory and
 Chassis Label
Date of Publication: October 14, 2020

Key Characteristics of the Change: Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:*	October 29, 2020
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes for the packaging and chassis regulatory labels of servers and chassis showed in "Products Affected" table:

1. Replace NYCE logo with NOM logo
2. Update NEMKO NTRL Logo



Figure 1. Chassis Label - Before



Figure 2. Chassis Label - After



Figure 3. Outer Package Label - Before



Figure 4. Outer Package Label - After

Customer Impact of Change and Recommended Action:

Intel does not expect any other impact to customers from these changes but encourages customers to understand the change and determine the impact on their applications. For that reason, Intel recommends that the customer perform a standard level of evaluation.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
R2208WF0ZSR	986050	K39997-007	K39997-008
R2312WFTZSR	986053	K40015-007	K40015-008

PCN Revision History:

Date of Revision:
October 14, 2020

Revision Number:
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Reason:
Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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